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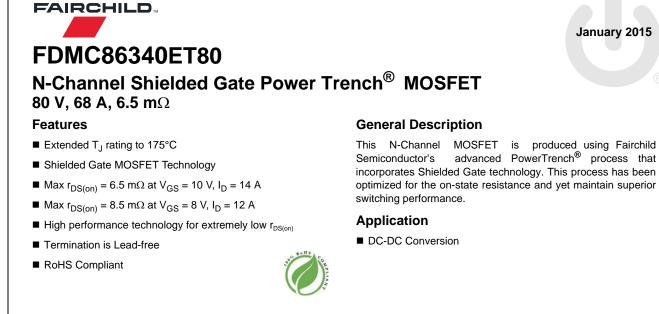


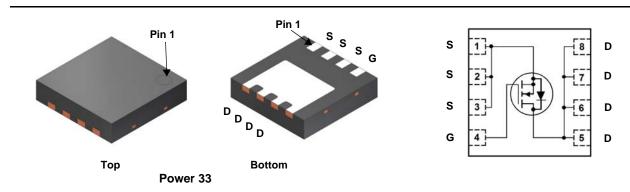
ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		Ratings	Units				
V _{DS}	Drain to Source Voltage				80	V	
V _{GS}	Gate to Source Voltage	9			±20	V	
	Drain Current -C	ontinuous	T _C = 25 °C	(Note 5)	68		
	-C	ontinuous	T _C = 100 °C	(Note 5)	48	•	
D	-C	ontinuous	T _A = 25 °C	(Note 1a)	14	Α	
	-P	ulsed		(Note 4)	316		
E _{AS}	Single Pulse Avalanch	e Energy		(Note 3)	216	mJ	
	Power Dissipation		T _C = 25 °C		65	14/	
P _D	Power Dissipation		T _A = 25 °C	(Note 1a)	2.8	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C		

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/VV

Package Marking and Ordering Information

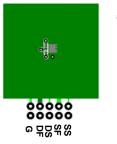
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86340ET	FDMC86340ET80	Power33	13 "	12 mm	3000 units

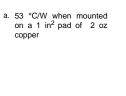
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	80			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		46		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 64 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	3.4	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 14 A		5.0	6.5	mΩ
	Static Drain to Source On Resistance	V _{GS} = 8 V, I _D = 12 A		6.0	8.5	
		V _{GS} = 10 V, I _D = 14 A, T _J = 125 °C		8.5	11	
9 _{FS}	Forward Transconductance	V _{DD} = 10 V, I _D = 14 A		36		S
010	-					
Dynamic	Characteristics			2775		pF
Dynamic C _{iss}						pF pF
Dynamic	Input Capacitance			2775		
Dynamic C _{iss} C _{oss}	Input Capacitance Output Capacitance		0.1	2775 468	2.1	pF
Dynamic C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance		0.1	2775 468 15	2.1	pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance		0.1	2775 468 15	2.1	pF pF
Dynamic C _{iss} C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics		0.1	2775 468 15 0.7		pF pF Ω
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz	0.1	2775 468 15 0.7 20	32	pF pF Ω ns
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 14 \text{ A},$	0.1	2775 468 15 0.7 20 7.9	32 16	pF pF Ω ns
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_d(off)$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 14 \text{ A},$	0.1	2775 468 15 0.7 20 7.9 23	32 16 37	pF pF Ω ns ns ns
Dynamic C_{iss} C_{oss} C_{rss} R_g Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		2775 468 15 0.7 20 7.9 23 5.1	32 16 37 10	pF pF Ω ns ns ns ns
$\begin{array}{c} \textbf{Dynamic} \\ \textbf{C}_{iss} \\ \textbf{C}_{oss} \\ \textbf{C}_{rss} \\ \textbf{R}_{g} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_{f} \\ \hline \textbf{Q}_{g(TOT)} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$	30	2775 468 15 0.7 20 7.9 23 5.1 38	32 16 37 10 49	pF pF Ω ns ns ns ns nc
$\begin{array}{c} \textbf{Dynamic} \\ \textbf{C}_{iss} \\ \textbf{C}_{oss} \\ \textbf{C}_{rss} \\ \textbf{R}_{g} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \textbf{t}_{r} \\ \hline \textbf{t}_{d(off)} \\ \textbf{t}_{f} \\ \hline \textbf{Q}_{g(TOT)} \\ \textbf{Q}_{g(TOT)} \\ \hline \textbf{Q}_{g(TOT)} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 40 \text{ V}, \text{ I}_{D} = 14 \text{ A},$ V_{GS} = 10 V, R_{GEN} = 6 \Omega $V_{GS} = 0 \text{ V to } 10 \text{ V}$ V_{GS} = 0 V to 8 V V_{DD} = 40 \text{ V},	30	2775 468 15 0.7 20 7.9 23 5.1 38 31	32 16 37 10 49	pF pF Ω ns ns ns nC nC

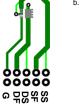
V _{SD} Sou	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 14 A$ (Note 2	2)	0.8	1.3	V
	Source to Drain Diode 1 of ward Voltage	$V_{GS} = 0 V, I_{S} = 1.9 A$ (Note 2	2)	0.7	1.2	V
t _{rr}	Reverse Recovery Time	I _E = 14 A, di/dt = 100 A/μs		41	66	ns
Q _{rr}	Reverse Recovery Charge	$T_{\rm F} = 14 {\rm A}, {\rm d} {\rm d} {\rm d} {\rm d} {\rm c} = 100 {\rm A} {\rm \mu s}$		25	40	nC

Notes:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.







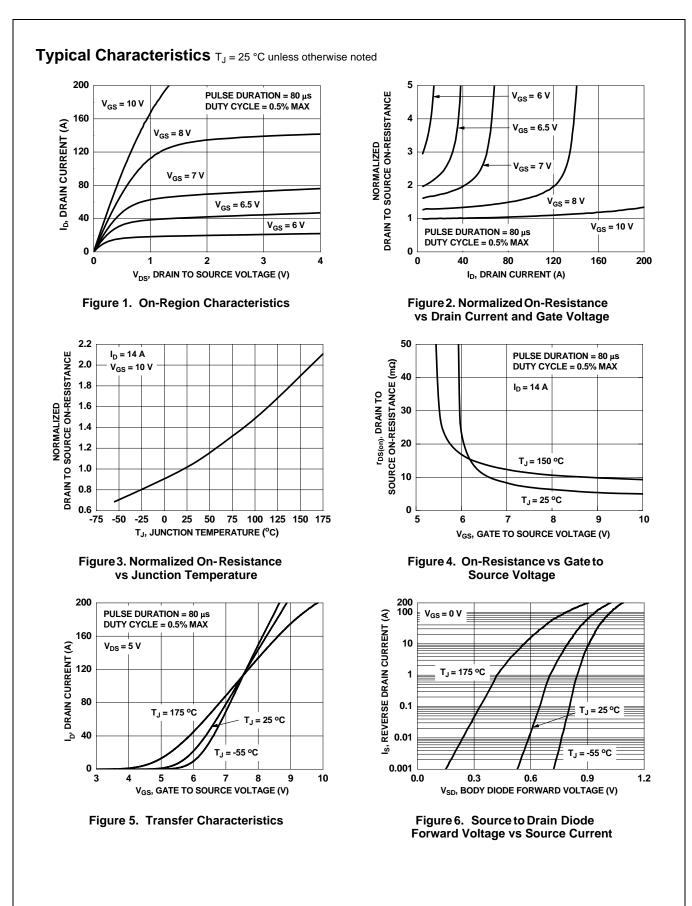
b. 125 °C/W when mounted on a minimum pad of 2 oz copper

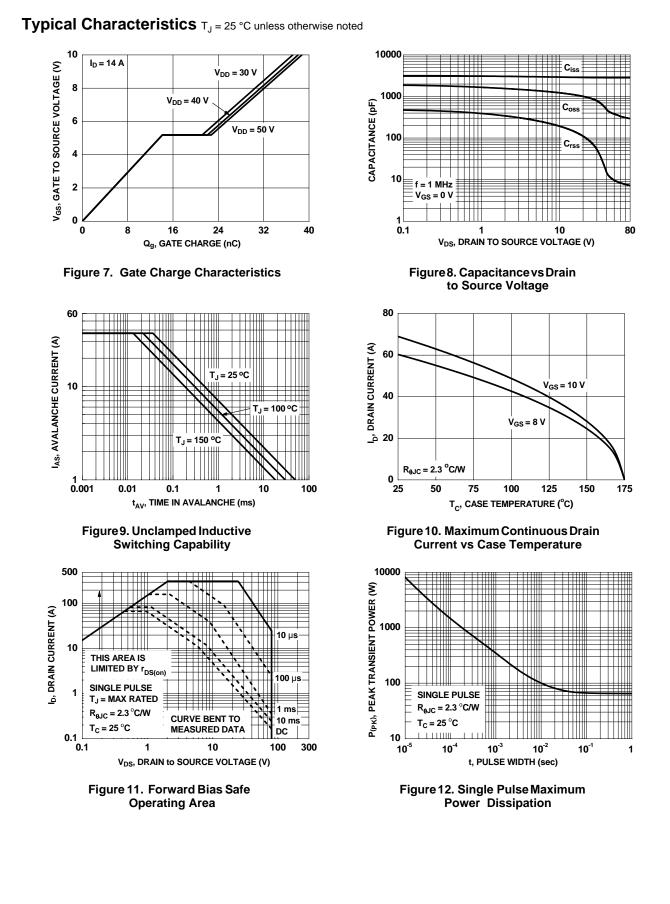
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

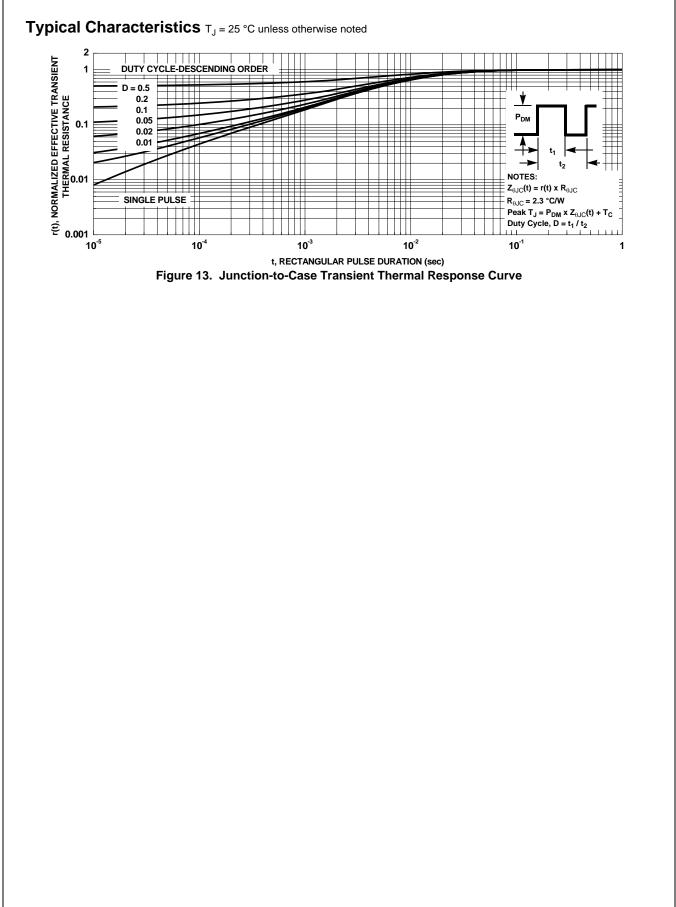
3. E_{AS} of 216 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 12 A, V_{DD} = 80 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 37 A.

4. Pulsed Id please refer to Fig 11 SOA graph for more details.

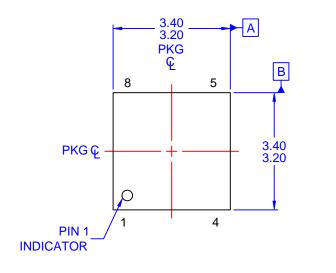
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

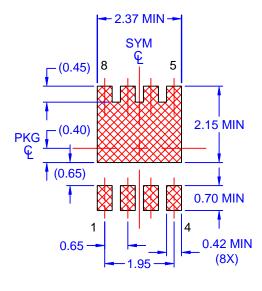




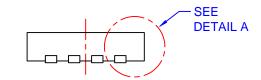


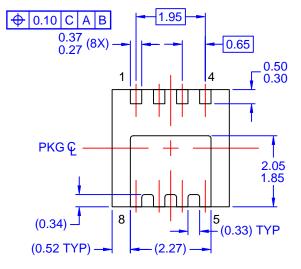
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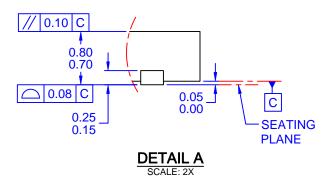












NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. BA, DATED OCTOBER 2002.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- E) DRAWING FILE NAME: PQFN08HREV1

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